



## LTC6258/LTC6259/LTC6260

## 1.3MHz, 20µA Power Efficient Rail-to-Rail I/O Op Amps

## **FEATURES**

Gain Bandwidth Product: 1.3MHz
 Low Quiescent Current: 20µA

■ C-Load<sup>™</sup> Op Amp Drives all Capacitive Loads

Offset Voltage: 400µV Maximum
 Rail-to-Rail Input and Output

Supply Voltage Range: 1.8V to 5.25V
 EMI Rejection Ratio: 45dB at 1GHz
 Input Bias Current: 75nA Maximum

■ CMRR/PSRR: 95dB/90dB

■ Shutdown Current: 7µA Maximum

Operating Temperature Range: –40°C to 125°C

Single in 6-Lead TSOT-23, 2mm × 2mm DFN Packages

Dual in 8-Lead MS8, MS10, TS0T-23, 2mm × 2mm DFN Packages

Quad in MS16 Package

## **APPLICATIONS**

- Micropower Active Filters
- Portable Instrumentation
- Battery or Solar Powered Systems
- Automotive Electronics

## DESCRIPTION

The LTC®6258/LTC6259/LTC6260 are single/dual/quad operational amplifiers with low noise, low power, low supply voltage, and rail-to-rail inputs and outputs. They are unity gain stable with or without capacitive loads. They feature 1.3MHz gain-bandwidth product, 0.24V/µs slew rate while consuming only 20µA of supply current per amplifier operating on supply voltages ranging from 1.8V to 5.25V. The combination of low supply current, low supply voltage, high gain bandwidth product and low noise makes the LTC6258 family unique among rail-to-rail input/output op amps with similar supply current. These operational amplifiers are ideal for power efficient applications.

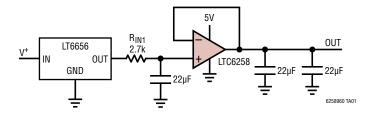
For applications that require power-down, the LTC6258 in 2mm  $\times$  2mm DFN and LTC6259 MS10 packages respectively offer shutdown which reduces the current consumption to  $7\mu A$  maximum.

The LTC6258 family can be used as plug-in replacements for many commercially available op amps to reduce power and improve input/output range and performance.

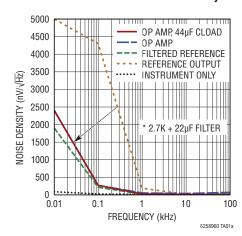
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## TYPICAL APPLICATION

#### **Low Noise Reference**



#### **Reference Buffer Noise Density**



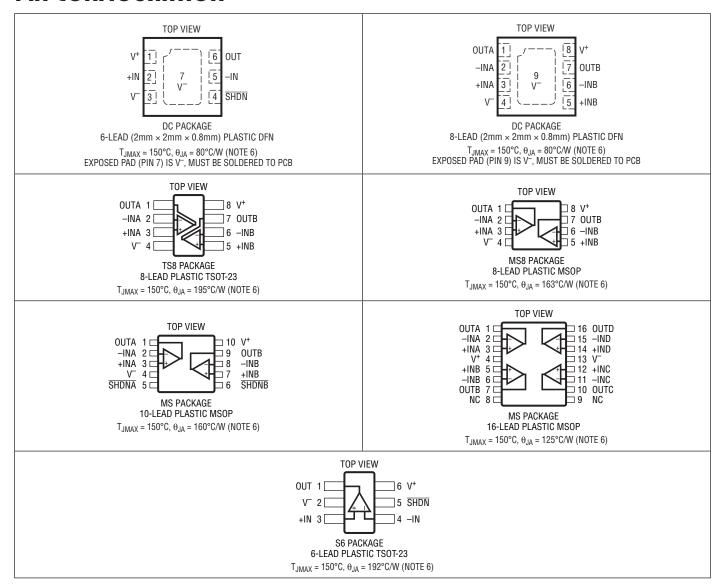
## **ABSOLUTE MAXIMUM RATINGS**

(Note 1)

Supply Voltage: V <sup>+</sup> – V <sup>-</sup>	5.5V
Input VoltageV <sup>-</sup>	$-0.2$ to $V^+ + 0.2$
Input Current: +IN, -IN, SHDN (Note 2)	±10mA
Output Current: OUT	±20mA
Output Short-Circuit Duration (Note 3)	Indefinite
Operating Temperature Range (Note 4)	40°C to 125°C

Specified Temperature Range (Note 5)	
LTC6258I/LTC6259I/LTC6260I	40°C to 85°C
LTC6258H/LTC6259H/LTC6260H	40°C to 125°C
Maximum Junction Temperature	150°C
Storage Temperature Range	65°C to 150°C
Lead Temperature (Soldering, 10 sec)	
TS8, MS8, MS only	300°C

## PIN CONFIGURATION



## ORDER INFORMATION http://www.linear.com/product/LTC6258#orderinfo

TAPE AND REEL (MINI)	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE
LTC6258IS6#TRMPBF	LTC6258IS6#TRPBF	LTGWD	6-Lead Plastic TSOT-23	-40°C to 85°C
LTC6258HS6#TRMPBF	LTC6258HS6#TRPBF	LTGWD	6-Lead Plastic TSOT-23	-40°C to 125°C
LTC6258IDC#TRMPBF	LTC6258IDC#TRPBF	LGZS	6-Lead Plastic DFN (2mm × 2mm × 0.8mm)	-40°C to 85°C
LTC6258HDC#TRMPBF	LTC6258HDC#TRPBF	LGZS	6-Lead Plastic DFN (2mm × 2mm × 0.8mm)	-40°C to 125°C
LTC6259ITS8#TRMPBF	LTC6259ITS8#TRPBF	LTGWX	8-Lead Plastic TSOT-23	-40°C to 85°C
LTC6259HTS8#TRMPBF	LTC6259HTS8#TRPBF	LTGWX	8-Lead Plastic TSOT-23	-40°C to 125°C
LTC6259IDC#TRMPBF	LTC6259IDC#TRPBF	LGWT	8-Lead (2mm × 2mm × 0.8mm) Plastic DFN	-40°C to 85°C
LTC6259HDC#TRMPBF	LTC6259HDC#TRPBF	LGWT	8-Lead (2mm × 2mm × 0.8mm) Plastic DFN	-40°C to 125°C
TUBE				
LTC6259IMS8#PBF	LTC6259IMS8#TRPBF	LTGWW	8-Lead Plastic MSOP	-40°C to 85°C
LTC6259HMS8#PBF	LTC6259HMS8#TRPBF	LTGWW	8-Lead Plastic MSOP	-40°C to 125°C
LTC6259IMS#PBF	LTC6259IMS8#TRPBF	LTGWY	10-Lead Plastic MSOP	-40°C to 85°C
LTC6259HMS#PBF	LTC6259HMS8#TRPBF	LTGWY	10-Lead Plastic MSOP	-40°C to 125°C
LTC6260IMS#PBF	LTC6260IMS#TRPBF	6260	16-Lead Plastic MSOP	-40°C to 85°C
LTC6260HMS#PBF	LTC6260HMS#TRPBF	6260	16-Lead Plastic MSOP	-40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container. Parts ending with PBF are RoHS and WEEE Compliant.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/.

## **5V ELECTRICAL CHARACTERISTICS** The ullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$ . $V_{SUPPLY} = 5V$ , $V_{CM} = V_{OUT} = V_{SUPPLY}/2$ , $C_L = 10pF$ , $V_{\overline{SHDN}}$ is unconnected.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V <sub>OS</sub>	Input Offset Voltage	$V_{CM} = V^- + 0.3V$	•	-400 -1000	100	400 1000	μV μV
		$V_{CM} = V^+ - 0.3V$	•	-400 -1000	100	400 1000	μV μV
$\Delta V_{OS}/\Delta T$	Input Offset Voltage Drift	$V_{CM} = V^- + 0.3V, V^+ - 0.3V$			1.5		μV/°C
I <sub>B</sub>	Input Bias Current (Note 7)	$V_{CM} = V^- + 0.3V$	•	-75	-5	75	nA
		$V_{CM} = V^+ - 0.3V$	•	-75	0	75	nA
I <sub>OS</sub>	Input Offset Current	$V_{CM} = V^- + 0.3V$	•	-75	-1	75	nA
		$V_{CM} = V^+ - 0.3V$	•	-75	-1	75	nA
e <sub>n</sub>	Input Voltage Noise Density	f = 1kHz			38		nV/√Hz
	Input Noise Voltage	f = 0.1Hz to 10Hz			2		μV <sub>P-P</sub>
i <sub>n</sub>	Input Current Noise Density	f = 1kHz, V <sub>CM</sub> = 0V to 4V f = 1kHz, V <sub>CM</sub> = 4V to 5V			500 500		fA/√Hz fA/√Hz
R <sub>IN</sub>	Input Resistance	Differential Common Mode		1 10			MΩ MΩ

## **5V ELECTRICAL CHARACTERISTICS** The ullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25\,^{\circ}$ C. $V_{SUPPLY} = 5V$ , $V_{CM} = V_{OUT} = V_{SUPPLY}/2$ , $C_L = 10$ pF, $V_{\overline{SHDN}}$ is unconnected.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
C <sub>IN</sub>	Input Capacitance	Differential Common Mode			0.65 1.2		pF pF
CMRR	Common Mode Rejection Ratio	$V_{CM} = 0.3V \text{ to } 3.5V$ $V_{CM} = -0.1V \text{ to } 5.1V$	•	66 64	95 95		dB dB
IVR	Input Voltage Range		•	-0.1		5.1	V
PSRR	Power Supply Rejection Ratio	$V_{CM} = 0.4V$ , $V_{S} = 1.8V$ to 5.25V	•	78 68	90		dB dB
	Supply Voltage Range		•	1.8		5.25	V
A <sub>V</sub>	Large Signal Gain	$V_{OUT} = 0.5V \text{ to } 4.5V, R_{LOAD} = 100k$	•	14 2.8	40		V/mV V/mV
		$V_{OUT} = 0.5V \text{ to } 4.5V, R_{LOAD} = 10k$	•	3.5 0.5	10		V/mV V/mV
$V_{OL}$	Output Swing Low (Input Overdrive 30mV). Measured from V <sup>-</sup>	No Load	•		12	40 50	mV mV
		I <sub>SINK</sub> = 100μA	•		80	105 120	mV mV
		I <sub>SINK</sub> = 1mA	•		145	180 250	mV mV
V <sub>OH</sub>	Output Swing High (Input Overdrive 30mV). Measured from V <sup>+</sup>	No Load	•		25	40 65	mV mV
		I <sub>SOURCE</sub> = 100μA	•		35	55 100	mV mV
		I <sub>SOURCE</sub> = 1mA	•		100	140 350	mV mV
I <sub>SC</sub>	Output Short-Circuit Current		•	4	10		mA mA
I <sub>S</sub>	Supply Current per Amplifier		•	16 11	20	23 25	μA μA
	Supply Current in Shutdown		•		4	5 7	μΑ μΑ
I <sub>SHDN</sub>	Shutdown Pin Current	V <sub>SHDN</sub> = 0.6V V <sub>SHDN</sub> = 1.5V	•		60 0	200 15	nA nA
$V_{IL}$	SHDN Input Low Voltage	Disable	•			0.6	V
$\overline{V_{IH}}$	SHDN Input High Voltage	Enable	•	1.5	,		V
t <sub>ON</sub>	Turn-On Time	SHDN Toggle from 0V to 5V			152		μs
t <sub>OFF</sub>	Turn-Off Time	SHDN Toggle from 5V to 0V			7		μs
GBW	Gain-Bandwidth Product	f = 10kHz	•	1.0 0.4	1.3		MHz MHz
$t_S$	Settling Time, 0.5V to 4.5V, Unity Gain	0.1% 0.01%			14 18		μs μs
SR	Slew Rate	$A_V = -1$ , $V_{OUT} = 0.5V$ to 4.5V, $C_{LOAD} = 10$ pF, $R_F = R_G = 10$ k $\Omega$	•	0.2 0.1	0.24		V/µs V/µs
FPBW	Full Power Bandwidth (Note 8)	4V <sub>P-P</sub>			20		kHz
THD+N	Total Harmonic Distortion and Noise	f = 500Hz, $A_V$ = 2, $R_L$ = 4kΩ, $V_{OUTP-P}$ = 1V $V_{IN}$ = 2.25V to 2.75V			0.025 72		% dB
I <sub>LEAK</sub>	Output Leakage Current in Shutdown	$V_{\overline{SHDN}} = 0V, V_{OUT} = 0V$ $V_{\overline{SHDN}} = 0V, V_{OUT} = 5V$	•		100 100		nA nA
%MP	Large Signal Overshoot	$V_{IN} = 0.5V$ to 4.5V, $A_V = 1$ , $C_L = 100nF$			2.7		%
EMIRR	Electromagnetic Interference Rejection Ratio	Input Power –10dB to Input Pins at 1GHz			45		dB

# **1.8V ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$ . $V_{SUPPLY} = 1.8V$ , $V_{CM} = V_{OUT} = 0.4V$ , $C_L = 10pF$ , $V_{\overline{SHDN}}$ is unconnected.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V <sub>OS</sub>	Input Offset Voltage	V <sub>CM</sub> = V <sup>-</sup> + 0.3V	•	-400 -1000	100	400 1000	μV μV
		$V_{CM} = V^+ - 0.3V$	•	-400 -1000	100	400 1000	μV μV
$\Delta V_{OS}/\Delta T$	Input Offset Voltage Drift	$V_{CM} = V^- + 0.3V, V^+ - 0.3V$			1.5		μV/°C
I <sub>B</sub>	Input Bias Current (Note 7)	$V_{CM} = V^- + 0.3V$	•	-75	2	75	nA
		$V_{CM} = V^+ - 0.3V$	•	-75	5	75	nA
I <sub>OS</sub>	Input Offset Current	$V_{CM} = V^- + 0.3V$	•	-75	2	75	nA
		$V_{CM} = V^+ - 0.3V$	•	-75	2	75	nA
e <sub>n</sub>	Input Voltage Noise Density	$f = 1kHz$ , $V_{CM} = 0.4V$			38		nV/√Hz
	Input Noise Voltage	f = 0.1Hz to 10Hz			2		μV <sub>P-P</sub>
i <sub>n</sub>	Input Current Noise Density	f = 1kHz, V <sub>CM</sub> = 0V to 0.8V f = 1kHz, V <sub>CM</sub> = 1V to 1.8V			500 500		fA/√Hz fA/√Hz
R <sub>IN</sub>	Input Resistance	Differential Common Mode		1 10			MΩ MΩ
C <sub>IN</sub>	Input Capacitance	Differential Common Mode			0.65 1.2		pF pF
CMRR	Common Mode Rejection Ratio	V <sub>CM</sub> = 0.2V to 1.6V	•	70 61	90		dB dB
IVR	Input Voltage Range		•	-0.1		1.9	V
PSRR	Power Supply Rejection Ratio	$V_{CM} = 0.4V$ , $V_{S} = 1.8V$ to 5.25V	•	78 68	90		dB dB
A <sub>V</sub>	Large Signal Gain	$V_{OUT} = 0.5V \text{ to } 1.3V, R_{LOAD} = 100k$	•	15 1.6	50		V/mV V/mV
		$V_{OUT} = 0.5V \text{ to } 1.3V, R_{LOAD} = 10k$	•	4 0.4	10		V/mV V/mV
V <sub>OL</sub>	Output Swing Low (Input Overdrive 30mV), Measured from V <sup>-</sup>	No Load	•		15	30 50	mV mV
		I <sub>SINK</sub> = 100μA	•		80	110 130	mV mV
		I <sub>SINK</sub> = 1mA	•		150	200 230	mV mV

## **1.8V ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$ . $V_{SUPPLY} = 1.8V$ , $V_{CM} = V_{OUT} = 0.4V$ , $C_L = 10$ pF, $V_{\overline{SHDN}}$ is unconnected.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
$V_{OH}$	Output Swing High (Input Overdrive 30mV), Measured from V <sup>+</sup>	No Load	•		25	40 50	mV mV
		I <sub>SOURCE</sub> = 100μA	•		35	60 100	mV mV
		I <sub>SOURCE</sub> = 1mA	•		95	140 300	mV mV
I <sub>SC</sub>	Output Short-Circuit Current		•	4	10		mA mA
I <sub>S</sub>	Supply Current per Amplifier		•	17 10	20	21 23	μA μA
	Supply Current in Shutdown		•		1.0	1.5 2	μA μA
I <sub>SHDN</sub>	Shutdown Pin Current	$V_{\overline{SHDN}} = 0.5V$ $V_{\overline{SHDN}} = 1.5V$	•		50 0	80 10	nA nA
$V_{IL}$	SHDN Input Low Voltage	Disable	•			0.5	V
V <sub>IH</sub>	SHDN Input High Voltage	Enable	•	1.5			V
$t_{ON}$	Turn-On Time	SHDN Toggle From 0V to 1.8V			47		μs
t <sub>OFF</sub>	Turn-Off Time	SHDN Toggle From 1.8V to 0V			17		μs
GBW	Gain-Bandwidth Product	f = 10kHz	•	1.0 0.4	1.3		MHz MHz
T <sub>S</sub>	Settling Time, 0.3V to 1.5V, Unity Gain	0.1% 0.01%			7 12		μs μs
SR	Slew Rate	$A_V = -1,\ V_{OUT} = 0.3V$ to 1.5V, $C_{LOAD} = 10 pF$ $R_F = R_G = 10 k\Omega$	•	0.16 0.1	0.22		V/µs V/µs
FPBW	Full Power Bandwidth (Note 8)	1.2V <sub>P-P</sub>			58		kHz
THD+N	Total Harmonic Distortion and Noise	$f$ = 500Hz, $A_V$ = 2, $R_L$ = 4k $\Omega,V_{OUTP\text{-}P}$ = 1V $V_{IN}$ = 0.65V to 0.15V			0.04 68		% dB

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** The inputs are protected by back-to-back diodes as well as ESD protection diodes to each power supply. If the differential input voltage exceeds 1.4V or the input extends more than 500mV beyond the power supply, the input current should be limited to less than 10mA.

**Note 3:** A heat sink may be required to keep the junction temperature below the absolute maximum rating when the output is shorted indefinitely.

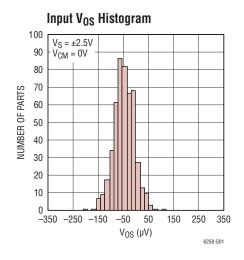
Note 4: LTC6258I/LTC6259I/LTC6260I and LTC6258H/LTC6259H/LTC6260H are guaranteed functional over the temperature range of -40°C to 125°C.

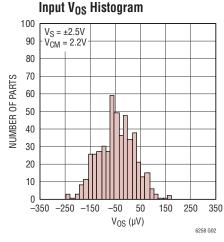
**Note 5:** The LTC6258I/LTC6259I/LTC6260I are guaranteed to meet specified performance from -40°C to 85°C. The LTC6258H/LTC6259H/LTC6260H are guaranteed to meet specified performance from -40°C to 125°C.

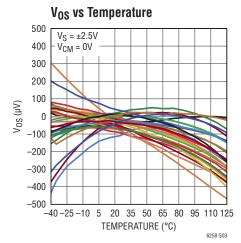
**Note 6:** Thermal resistance varies with the amount of PC board metal connected to the package. The specified values are for short traces connected to the leads.

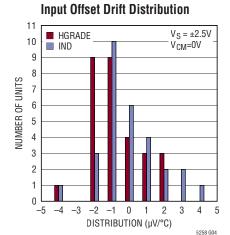
**Note 7:** The input bias current is the average of the currents into the positive and negative input pins.

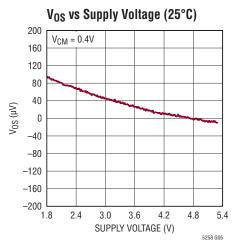
**Note 8:** Full power bandwidth is calculated from the slew rate FPBW =  $SR/\pi \cdot V_{P-P}$ .

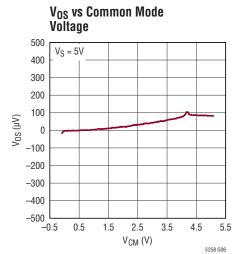


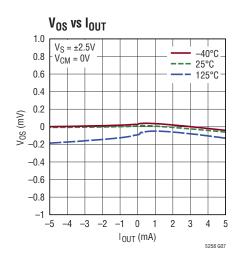


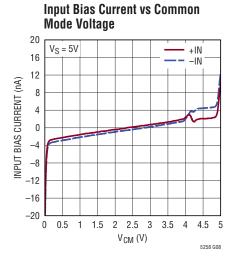


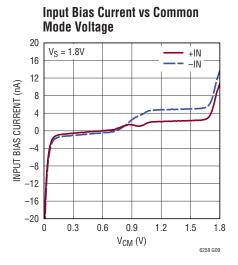




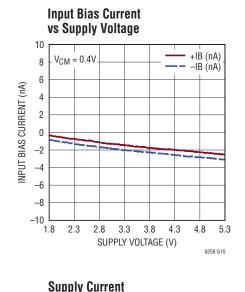


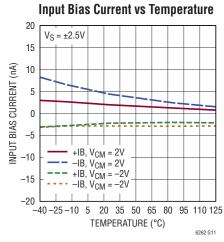


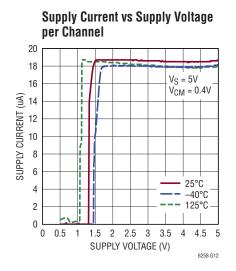


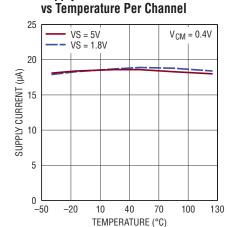


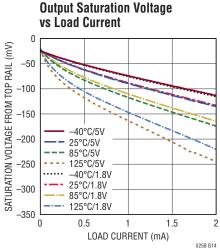
6258 G13

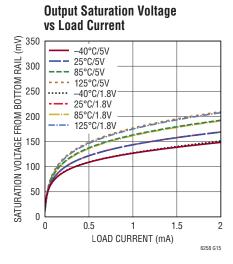


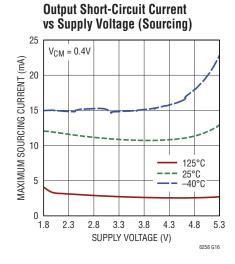


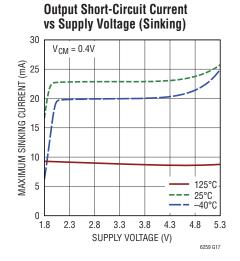


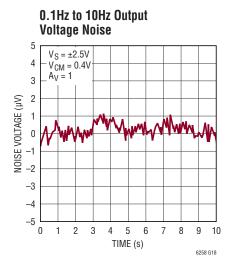


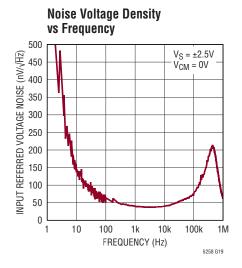


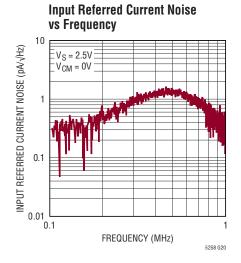


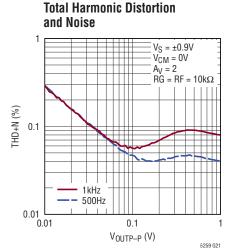


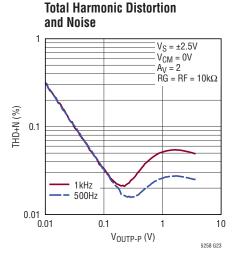


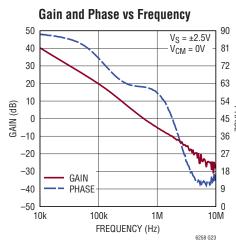


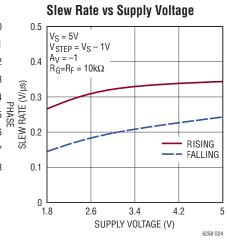


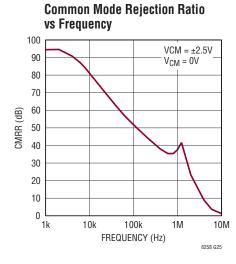


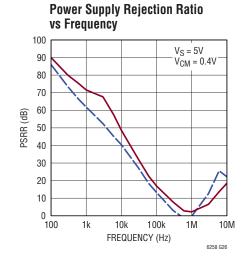


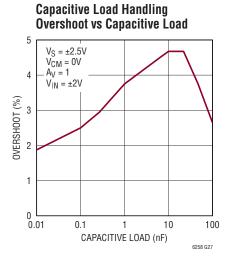


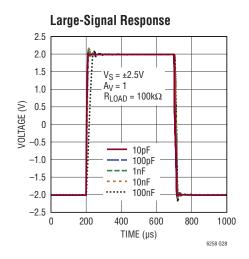


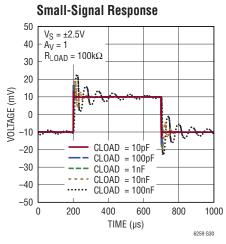


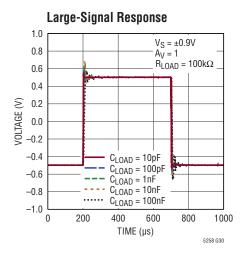


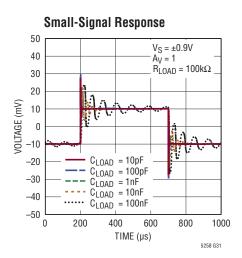


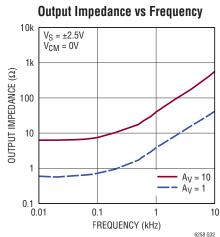


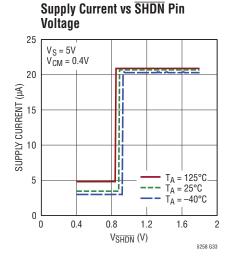


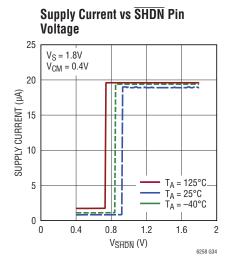


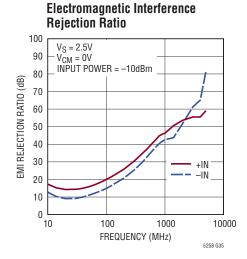












## PIN FUNCTIONS

**–IN:** Inverting Input of the Amplifier. Voltage range of this pin can go from  $V^- - 0.1V$  to  $V^+ + 0.1V$ .

**+IN:** Noninverting Input of Amplifier. This pin has the same voltage range as -IN.

**V+:** Positive Power Supply. Typically the voltage is from 1.8V to 5.25V. Split supplies are possible as long as the voltage between V+ and V<sup>-</sup> is between 1.8V and 5.25V. A bypass capacitor of  $0.1\mu F$  as close to the part as possible should be used between power supply pins or between supply pins and ground.

**V**<sup>-</sup>: Negative Power Supply. It is normally tied to ground. It can also be tied to a voltage other than ground as long as the voltage between V<sup>+</sup> and V<sup>-</sup> is from 1.8V to 5.25V. If it is not connected to ground, bypass it with a capacitor of 0.1µF as close to the part as possible.

**SHDN**: Active Low Shutdown. Shutdown threshold is 0.6V above negative rail. If left unconnected, the amplifier will be on.

**OUT:** Amplifier Output. Rail-to rail amplifier output capable of delivering 4mA.

## SIMPLIFIED SCHEMATIC

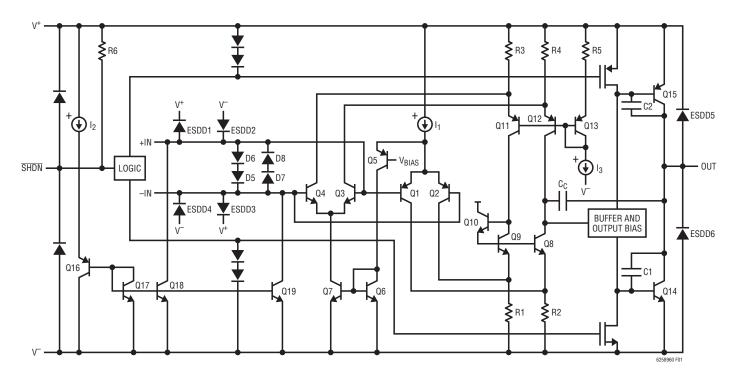


Figure 1. LTC6258/LTC6259/LTC6260 Simplified Schematic

## **OPERATION**

The LTC6258 family input signal range extends beyond the negative and positive power supplies. Figure 1 depicts a Simplified Schematic of the amplifier. The input stage is comprised of two differential amplifiers, a PNP stage Q1/Q2 and NPN stage Q3/Q4 that are active over different ranges of common mode input voltage. The PNP stage is active between the negative power supply to approximately 1V below the positive supply. As the input voltage approaches the positive supply, transistor Q5 will steer the tail current  $I_1$  to the current mirror Q6/Q7, activating the NPN differential pair and the PNP pair becomes inactive for the remaining input common mode range. Also for the

input stage, devices Q17, Q18 and Q19 act to cancel the bias current of the PNP input pair. When Q1/Q2 is active, the current in Q16 is controlled to be the same as the current Q1/Q2. Thus, the base current of Q16 is normally equal to the base current of the input devices of Q1/Q2. Similar circuitry (not shown) is used to cancel the base current of Q3/Q4. The buffer and output bias stage uses a special compensation technique to take full advantage of the process technology to drive high capacitive loads. The common emitter topology of Q14/Q15 enables the output to swing from rail to rail.

### **Low Supply Voltage and Low Power Consumption**

The LTC6258 family of operational amplifiers can operate with power supply voltages from 1.8V to 5.25V. Each amplifier draws 20µA. The low supply voltage capability and low supply current are ideal for portable applications.

## High Capacitive Load Driving Capability and Wide Bandwidth

The LTC6258 family is optimized for wide bandwidth low power applications. They have a high gain-bandwidth to power ratio and are unity gain stable. When the load capacitance increases, the increased capacitance at the output pushes the non-dominant pole to lower frequency in the open loop frequency response, worsening the phase and gain margin. The LTC6258 family are designed to directly drive up to 100nF of capacitive load in unity gain configuration (see Typical Performance Characteristics, Capacitive Load Handling).

#### **Low Input Referred Noise**

The LTC6258 family provides a low input referred noise of  $38nV/\sqrt{Hz}$  at 1kHz. The average noise voltage density over a 100kHz bandwidth is less than  $80nV/\sqrt{Hz}$ . The LTC6258 family is ideal for low noise and low power signal processing applications.

#### **Low Input Offset Voltage**

The LTC6258 family has a low offset voltage of  $400\mu\text{V}$ , which is essential for precision applications. The offset voltage is trimmed with a proprietary trim algorithm to ensure low offset voltage over the entire common mode voltage range.

#### **Low Input Bias Current**

The LTC6258 family uses a bias current cancellation circuit to compensate for the base current of the input transistors. When the input common mode voltage is within 200mV of either rail, the bias cancellation circuit is no longer active. For common mode voltages ranging from 0.2V above the negative supply to 0.2V below the positive supply, the low input bias current allows the amplifiers to be used in applications with high resistance sources.

#### **Ground Sensing and Rail to Rail Output**

The LTC6258 family delivers over 4mA of output drive current. The output stage is a rail-to-rail topology that is capable of swinging to within 300mV of either rail. If output swing to the negative rail is required, an external pull down resistor to a negative supply can be added. For 5V/0V op amp supplies, a pull down resistor of 10k to –2V will allow a 'true zero' output swing. In this case, the output can swing all the way to the bottom rail while maintaining 45dB of open loop gain. Since the inputs can go 100mV beyond either rail, the op amp can easily perform 'true ground' sensing.

The maximum output current is a function of total supply voltage. As the supply voltage to the amplifier increases, the maximum output current also increases. Attention must be paid to keep the junction temperature of the IC below 150°C when the output is in continuous short-circuit. The output of the amplifier has reverse-biased diodes connected to each supply. The output should not be forced more than 0.5V beyond either supply, otherwise current will flow through these diodes.

#### **EMI Rejection**

Electromagnetic interference (EMI) rejection is built into the LTC6258 op amp family. Rejection is measured by injecting  $200mV_{P-P}$  (-10dBm) RF signal into the pins and measuring the offset change (delta\_VOS). The rejection ratio is calculated as 20log ( $100mV/delta_VOS$ ).

#### **Input Protection and Output Overdrive**

To prevent breakdown of the input transistors, the input stages are protected against a large differential input voltage by two pairs of back-to-back diodes, D5 to D8. If the differential input voltage exceeds 1.4V, the current in these diodes must be limited to less than 10mA. These amplifiers are not intended for open loop applications such as comparators. When the output stage is overdriven, internal limiting circuitry is activated to improve overdrive recovery. In some applications, this circuitry may draw as much as 1mA supply current.

#### **ESD**

The LTC6258 family has reverse-biased ESD protection diodes on all inputs and output as shown in Figure 1.

#### **Supply Voltage Ramping**

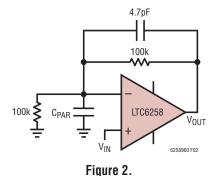
Fast ramping of the supply voltage can cause a current glitch in the internal ESD protection circuits. Depending on the supply inductance, this could result in a supply voltage transient that exceeds the maximum rating. A supply voltage ramp time of greater than 1ms is recommended.

### **Feedback Components**

Care must be taken to ensure that the pole formed by the feedback resistors and the parasitic capacitance at the inverting input does not degrade stability. For example, in a gain of +2 configuration with gain and feedback resistors of 100k, a poorly designed circuit board layout with parasitic capacitance of 5pF (part +PC board) at the amplifier's inverting input will cause the amplifier to oscillate due to a pole formed at 640kHz. An additional capacitor of 4.7pF across the feedback resistor as shown in Figure 2 will eliminate any ringing or oscillation.

#### Shutdown

The single and dual versions have package options with  $\overline{SHDN}$  pins that can shut down the amplifier to less than  $7\mu A$  supply current. The  $\overline{SHDN}$  pin voltage needs to be within 0.6V of V<sup>-</sup> for the amplifier to shut down. During shutdown, the output is in a high output impedance state. When left floating, the  $\overline{SHDN}$  pin is internally pulled up to the positive supply and the amplifier remains enabled.



#### **Active Filter**

The bandpass filter Figure 3a is AC-coupled to an input. As a result, LTC6259 input does not place a burden on the previous stage to develop an absolute common mode voltage. A simple resistor divider with RA1 and RA2 provides biasing for the LTC6259 inputs. Pegging the op amp inputs to a fixed voltage helps to reduce distortion that might arise with moving common mode. This filter is centered at 10kHz. The exact resistance and capacitance values can be tweaked upwards or downwards, depending on whether lowest resistor noise or lowest total supply current is more important.

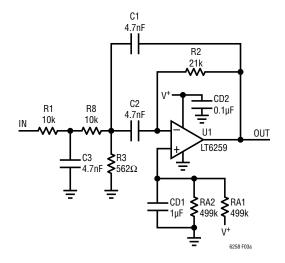


Figure 3a. 10kHz Bandpass Filter

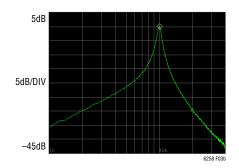


Figure 3b. Frequency Response of 10kHz Bandpass Filter of Figure 3a

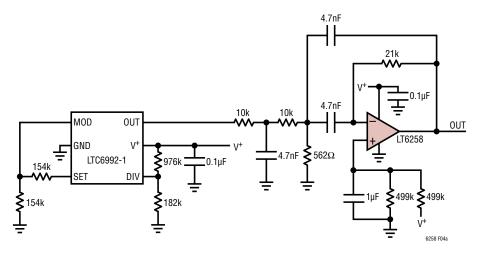


Figure 4a. Low Power Squarewave - Sinewave Oscillator

#### Low Power Sine Wave Generator

A low power sine wave generator can be derived by driving a square wave into the bandpass filter. A complete schematic is shown in Figure 4a. The LTC6992-1 easily configures as a 50% duty cycle 10kHz square wave, and can drive the relatively benign loading seen in the bandpass filter.

Figures 4b and 4c show the LTC6992-1 output and bandpass filter output. THD of the sine wave is -30.5 dBc. Note, even harmonics that appear in the distortion products of the filtered output already appear in the source square wave.

#### Low Noise Reference

The LT6656 is a 1 $\mu$ A precision series voltage reference. Yet with low power comes low drive current capability and higher noise. The LTC6259 can be used as a buffer that follows a filter to enhance the utilization of the LT6656 in low power applications. Figure 5a shows such a configuration. First a very low cutoff frequency follows the LT6656 output ( $R_{IN1}$  and  $C_{IN1}$ , lower than 5Hz cutoff). Choice of filter resistor  $R_{IN1}$  is such that the bias current in the LTC6259, multiplied by the resistance value, is lower than the nominal offset voltage of the op amp.  $C_{IN1}$  can be larger or smaller, with more or less filtering accordingly. The voltage withstanding requirement of  $C_{IN1}$  is low, resulting in large capacitance in a small volume.

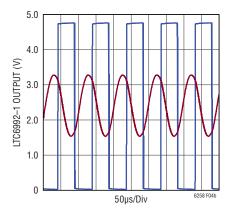


Figure 4b. Low Power Sine Generator

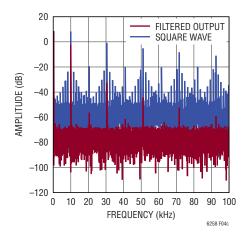


Figure 4c. FFT

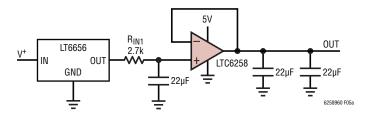


Figure 5a. Low Noise Reference Use LT6656 for a Low Current Starting Reference

This circuit takes advantage of the ability of the LTC6259 to drive large capacitive loads. Use of a large output capacitor attached to the LT6659 enables significant bypassing of follow-on circuits that use the reference voltage. In total, the combination of LT6656 and LTC6259, in this configuration, develops a reference voltage, with low noise, at low power, and with appreciably large available bypass capacitance.

Voltage spectral noise densities are shown in Figure 5b. Larger noise from the reference below 10kHz noticeably drops down once a filter ( $R_{IN1}$  and  $C_{IN1}$ ) follow the reference. The op amp, configured in unity gain, with a large 44 $\mu F$  load, remains stable and contributes only a small amount of low frequency noise. Figure 5c shows the transient response of the combination of  $R_{IN1}\text{-}C_{IN1}$  filter and op amp circuit, with and without the 44 $\mu F$  output capacitor.

Figure 5c shows the time domain response of the reference buffer.

The total measured supply current consumption is 21µA.

#### **Analog LED Control**

Figure 6a shows a voltage controlled LED drive circuit. When  $V_{IN}$  is at 0V, the op amp supply current is nominally  $20\mu A.$  The offset, for example, could be  $450\mu V,$  appears across R1, inducing a 0.45mA current in the LED. Some applications want a guaranteed zero LED current at  $V_{IN}=0,$  and this is the purpose of R5. R5 forces  $2.5\mu A$  current through R7, creating a negative 0.6mV sense offset. This offset guarantees a zero LED current.

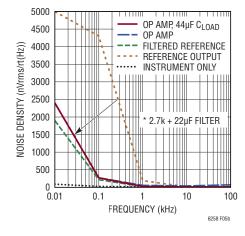


Figure 5b. Noise Density, Reference Buffer

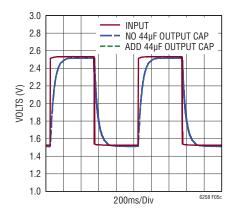


Figure 5c. Reference Buffer Transient Response

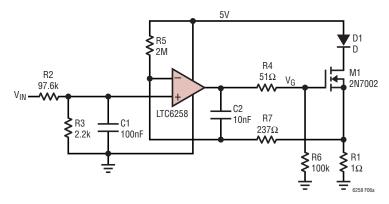


Figure 6a. Lower Power LED Driver with Voltage Command

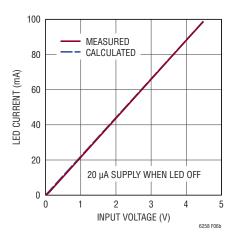


Figure 6b. LED Current

Indeed, the circuit works nicely. Once the input voltage is near 0, the LED current output is 0 and the total supply current is  $20\mu A$ . Gain from the input voltage to LED current is 0.022A/V, as can be taken from the R2/R3 voltage divider and the sense resistor value.

$$LED Current = \frac{V_{IN}}{R1} \cdot \frac{R3}{R2 + R3}$$

#### Self-Oscillating LED Driver

Taking the circuit of the above application a step further, the circuit of Figure 7a combines edge detection with use of the shutdown pin of the LTC6259. R2 and R3 bring in a divided down copy of the supply voltage as a reference into the positive terminal. The op amp forces this voltage on the sense resistor  $R_{SENSE}$  in "LED ON" operation. In that sense this circuit is similar to the one above.

However, whereas the previous circuit assumes an always-on operation mode, this new circuit hijacks the shutdown pin. C2 can AC couple fast action signals into the signal V<sub>C</sub>. Hence when the gate voltage V<sub>G</sub> increases when "LED ON" begins, V<sub>C</sub> will suddenly rise. V<sub>C</sub> connects to the shutdown pin; a rising edge on the shutdown pin enables the LTC6259, which is already active, to stay on. However, M3 is also on while M1 is on, and as a result will work with R9 to charge C2 slowly until V<sub>C</sub> falls below the shutdown threshold. At that moment, the active low shutdown kicks in, and the LTC6259 turns off. A negative falling V<sub>G</sub> voltage again feeds through C2, and a falling V<sub>C</sub> and hence a falling shutdown pin voltage keeps the circuit in an "LED OFF" state for some time. M3 turns off, and C2 discharges until V<sub>C</sub> is high enough to reactivate the LTC6259.

It may seem a bit odd to develop such a circuit when a microprocessor or a LTC6992 can provide on-off capability in combination with a single MOSFET and resistor. The problem with those circuits, however, is the lack of control over the LED current. In the circuit of this application, a voltage is controlled across a sense resistor. There is no dependence on the LED voltage in how much current drives the LED. And generation of the on-off, or blinking, comes with the addition of only a handful of low cost components.

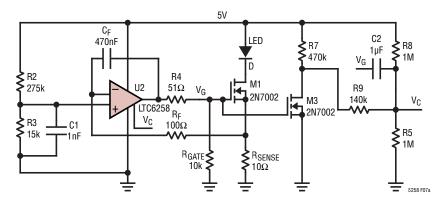


Figure 7a. LED Driver with Self-Oscillation

It is interesting to note that the LED current depends on the supply in this implementation in as much as the supply feeds through R2 and R3 to create a reference. The supply also figures into the time of the on and off cycle since the supply powers the edge detection and relaxation part of the circuitry. When the supply falls, the LED current drops and the cycle time increases. This change of behavior can help in battery powered LED blinking applications to predict end of life.

The figure shows the sense resistor voltage (red) and the shutdown pin voltage (blue). The shutdown voltage is tied to  $V_{\text{C}}$ ; the gate drive couples through C2 as already described.

Components  $R_F$  and  $C_F$  may apparently slow edges down greatly. Adding this much delay is not essential, but it can help to smooth out any hiccups that occur when the part goes through a startup sequence after the shutdown pin goes inactive. 47 $\mu$ s as a time constant is insignificant in the time scale of the blinking (10's or 100's of ms). The 47 $\mu$ s is much smaller than any time constant associated with C2 and its resistors.

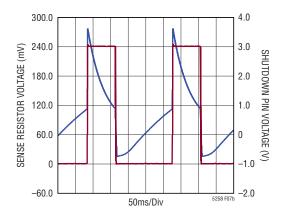
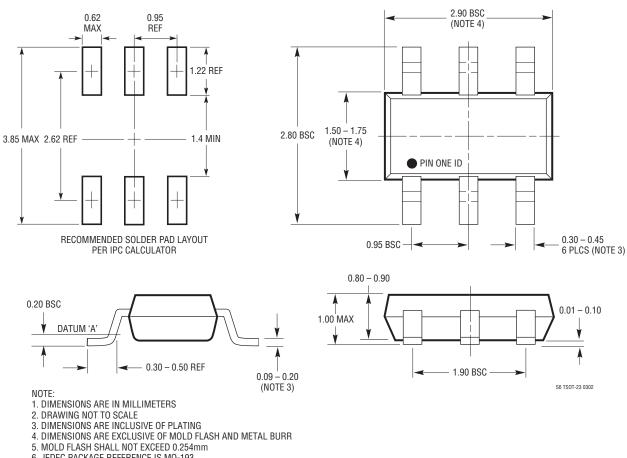


Figure 7b. LED Blinker Circuit

Please refer to http://www.linear.com/product/LTCLTC6258#packaging for the most recent package drawings.

#### S6 Package 6-Lead Plastic TSOT-23

(Reference LTC DWG # 05-08-1636)

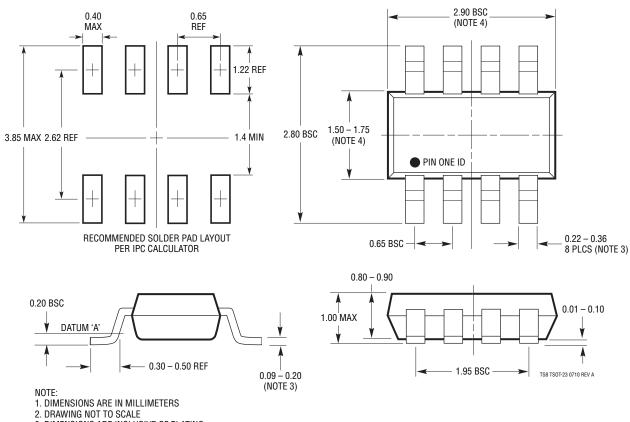


- 6. JEDEC PACKAGE REFERENCE IS MO-193

Please refer to http://www.linear.com/product/LTC6259#packaging for the most recent package drawings.

#### TS8 Package 8-Lead Plastic TSOT-23

(Reference LTC DWG # 05-08-1637 Rev A)

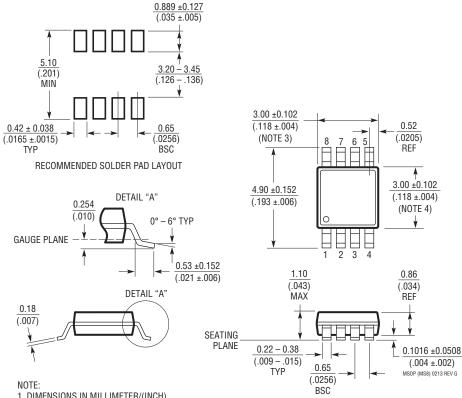


- DIMENSIONS ARE INCLUSIVE OF PLATING
   DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
- 5. MOLD FLASH SHALL NOT EXCEED 0.254mm
- 6. JEDEC PACKAGE REFERENCE IS MO-193

Please refer to http://www.linear.com/product/LTC6259#packaging for the most recent package drawings.

#### **MS8 Package** 8-Lead Plastic MSOP

(Reference LTC DWG # 05-08-1660 Rev G)

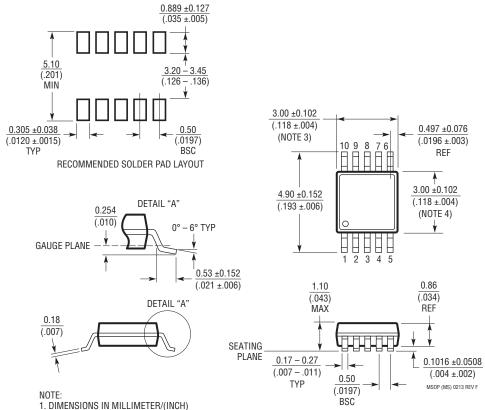


- 1. DIMENSIONS IN MILLIMETER/(INCH)
  2. DRAWING NOT TO SCALE
- 3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE 5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

Please refer to http://www.linear.com/product/LTC6259#packaging for the most recent package drawings.

#### **MS Package** 10-Lead Plastic MSOP

(Reference LTC DWG # 05-08-1661 Rev F)



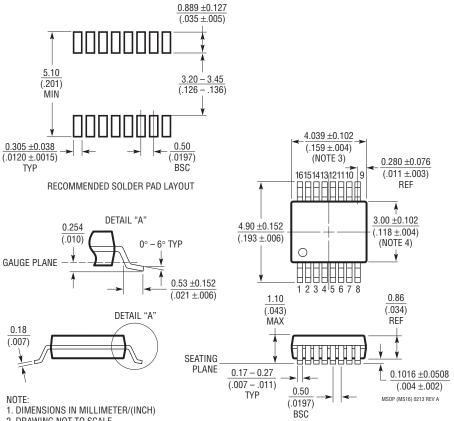
- 2. DRAWING NOT TO SCALE
- 3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

  MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
  INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

Please refer to http://www.linear.com/product/LTC6260#packaging for the most recent package drawings.

#### **MS Package** 16-Lead Plastic MSOP

(Reference LTC DWG # 05-08-1669 Rev A)

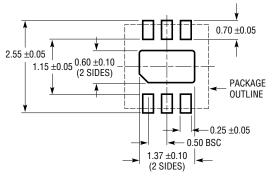


- 2. DRAWING NOT TO SCALE
- DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
   MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS. INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
- 5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

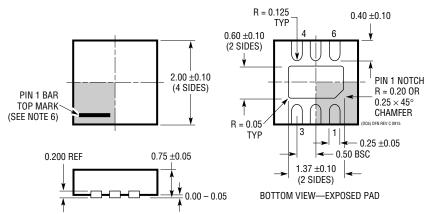
Please refer to http://www.linear.com/product/LTC6258#packaging for the most recent package drawings.

## $\begin{array}{c} \text{DC6 Package} \\ \text{6-Lead Plastic DFN (2mm} \times \text{2mm)} \end{array}$

(Reference LTC DWG # 05-08-1703 Rev C)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS



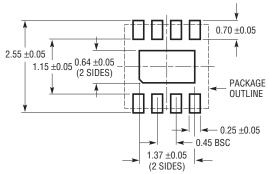
#### NOTE:

- 1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WCCD-2)
- 2. DRAWING NOT TO SCALE
- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
- 5. EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

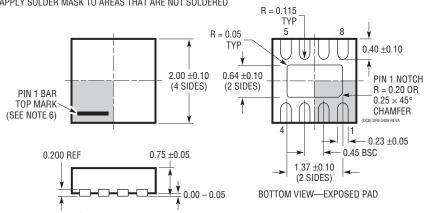
Please refer to http://www.linear.com/product/LTC6259#packaging for the most recent package drawings.

#### 

(Reference LTC DWG # 05-08-1719 Rev A)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



- 1. DRAWING IS NOT A JEDEC PACKAGE OUTLINE
- 2. DRAWING NOT TO SCALE
- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
- 5. EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

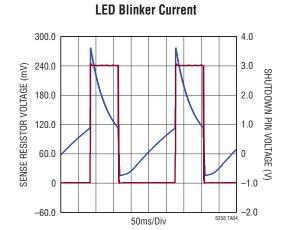
## **REVISION HISTORY**

REV	DATE	DESCRIPTION	PAGE NUMBER
Α	04/17	Added SOT-23 package.	1, 2, 3, 20

## TYPICAL APPLICATION

#### **LED Driver with Self Oscillation**

#### C<sub>F</sub> 470nF LED ≹R7 470k ₹R8 1M 1μF V<sub>G</sub> Б **R**2 275k R4 51Ω V<sub>G</sub> M1 R9 2N7002 LTC6258 R<sub>F</sub> МЗ 140k $\text{V}_{\text{C}}$ 2N7002 **₹**R3 $\nu_{\text{C}}$ **-** C1 100Ω **₹**R5 15k 1nF R<sub>SENSE</sub> 10Ω 6258 TA03



## **RELATED PARTS**

PART NUMBER	DESCRIPTION	COMMENTS
LTC6255/LTC6256/ LTC6257	6.5MHz, 65µA Power Efficient RR Op Amp	6.5MHz, 65μA, RR IN/OUT, 1.8V to 5.25V
LTC6261/LTC6262/ LTC6263	30MHz, 240μA Power Efficient RR Op Amp	30MHz, 240μA, RR IN/OUT, 1.8V to 5.25V
LTC6246/LTC6247/ LTC6248	180MHz, 1mA, Power Efficient Rail-to-Rail Op Amps	180MHz GBW, 1mA, 500μV V <sub>OS</sub> , RR In/Out, 2.5V to 5.25V, 90V/μs Slew Rate
LT1498/LT1499	10MHz, 6V/µs, Dual/Quad,Rail-to-Rail Input and Output, Precision C-Load Op Amps	10MHz GBW, 1.7mA, 475μV V <sub>OS</sub> , RR In/Out, 2.2V to ±15V, 10nF C <sub>LOAD</sub>
LTC6081/LTC6082	Precision Dual/Quad CMOS Rail-to-Rail Input/Output Amplifiers	3.6MHz GBW, 330μA, 70μV V <sub>OS</sub> , RR In/Out, 2.7V to 5.5V, 100dB CMRR
LTC2050/LTC2051/ LTC2052	Zero-Drift Operational Amplifiers in SOT-23	3MHz GBW, 800 $\mu$ A, 3 $\mu$ V V <sub>OS</sub> , V <sup>-</sup> to V <sup>+</sup> – 1V In, RR Out, 2.7V to 6V, 130dB CMRR/PSRR
LTC1050/LTC1051/ LTC1052	Precision Zero-Drift, Operational Amplifierwith Internal Capacitors	2.5MHz GBW, 1mA, 5µV V $_{0S}$ , V $^-$ to V $^+$ – 2.3V In, RR Out, 4.75V to 16V, 120dB CMRR, 125dB PSRR
LTC6084/LTC6085	Dual/Quad 1.5MHz, Rail-to-Rail, CMOS Amplifiers	1.5MHz GBW, 110μA, 750μV V <sub>OS</sub> , RR In/Out, 2.5V to 5.5V
LT1783	1.25MHz, Over-The-Top® Micropower, Rail-to-Rail Input and Output Op Amp in SOT-23	1.25MHz GBW, 300μA, 800μV V <sub>OS</sub> , RR In/Out, 2.5V to 18V
LT1637/LT1638/ LT1639	1.1MHz, 0.4V/µs Over-The-Top Micropower, Rail-to-Rail Input and Output Op Amps	1.1MHz GBW, 250μA, 350μV V <sub>OS</sub> , RR In/Out, 2.7V to 44V, 110dB CMRR
LTC2054/LTC2055	Single/Dual Micropower Zero-Drift Operational Amplifiers	500kHz GBW, 150μA, 3μV V <sub>OS</sub> , V <sup>-</sup> to V <sup>+</sup> – 0.5V In, RR Out, 2.7V to 6V
LT6010/LT6011/ LT6012	135µA, 14nV/√Hz, Rail-to-Rail Output Precision Op Amp with Shutdown	$330 kHz$ GBW, $135 \mu A,  35 \mu V  V_{OS},  V^-$ + 1.0V to $V^+$ – 1.2V In, RR Out, 2.7V to 36V
LT1782	Micropower, Over-The-Top, SOT-23, Rail-to-Rail Input and Output Op Amp	200kHz GBW, 55μA, 800μV V <sub>OS</sub> , RR In/Out, 2.5V to 18V
LT1636	Over-The-Top, Micropower Rail-to-Rail, Input and Output Op Amp	200kHz GBW, 50μA, 225μV V <sub>OS</sub> , RR In/Out, 2.7V to 44V, -40°C to 125°C
LT1490A/LT1491A	Dual/Quad Over-The-Top, Micropower Rail-to-Rail Input and Output Op Amps	200kHz GBW, 50μA, 500μV V <sub>OS</sub> , RR In/Out, 2V to 44V
LT2178/LT2179	17μA Max, Dual and Quad, Single Supply, Precision Op Amps	85kHz GBW, 17μA, 70μV V <sub>OS</sub> , RR In/Out, 5V to 44V
LT6000/LT6001/ LT6002	Single, Dual and Quad, 1.8V, 13µA Precision Rail-to-Rail Op Amps	50kHz GBW, 16μA , 600μV V <sub>OS(MAX)</sub> , RR In/Out, 1.8V to 18V

